UNDERSTANDING AND PROCESSING OF THE FIELD EMISSION ENHANCED BY CONDUCTING PROTRUSIONS

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ABSTRACT

In the last decades, several investigation on enhanced field emission from metallic surfaces pointed out the importance of intrinsic surface defects and particle contamination, as potential emitters. Today, chemical or electropolishing on the one hand and high pressure water rinsing on the second hand, give very high performance single cell niobium cavity (E_{acc} = 30-40 MV.m⁻¹). Nevertheless, it seems difficult to reach identical performances on nine cells cavities. Thus, a better understanding of the emitting and processing mechanisms of the most potential emitters : conducting protrusions, appears still useful. Our experimental results showed a high consistency with the explanation that field enhancement factor β , in the Fowler-Nordheim's law, came from a geometrical effect due to the superposition of nanometer size protrusions on micron size ones. A comparison of β and A_e -the effective emitting area- of the same emitter in DC and RF regime gave the same values. Furthermore, it was possible to check that a craterlike defect presented an emission on the rim, in the both DC and RF regimes. According to the geometrical explanation, smoothing a protrusion should strongly reduce the emission. This prediction was verified by using a thermal and a mechanical treatment. At last, the in situ RF processing, called High Peak Power Processing, had been simulated on small samples, manufactured in different metals. The results had not indicated a significant dependence on the material properties, but pointed out the role of a high current density. A value near 10^{12} A.m⁻² initiated a run away event that ended in the emitter explosion.

1. - INTRODUCTION

Electron emission from a metallic surface submitted to a high electric field appeared long ago as an endemic problem for DC or RF devices operating at high voltage, because of the resulting leak current and breakdown risk. In accelerating RF cavities, especially in superconducting ones, this field emission set up a severe and high cost limitation. It prevented from constructing short accelerator modules. During the last decades, many experiments had been undertaken separately in DC and RF regime, either on small samples or on large surfaces as cavities. They identified potential emitters as being microscopic random contamination particles or surface defects, like scratches or inclusions. Experimental observations proved there should not be only a single mechanism responsible for enhanced field emission. Since the emitters could have insulator, semi-conductor or conductor properties. An underlying physical mechanism had been proposed for each case : filament and hot electron explanation for insulators and semi-conductors [1, 2], superposed metallic protrusions for conductors [3]. Nevertheless, according to Maley [4] and Jimenez [5], it appeared that conducting contaminants caused stronger field emitted currents, with low field threshold, and made the contaminated devices more difficult to condition. For this reason, the conducting protrusions deserved an extended investigation.

2. - EMISSION PROPERTIES IN DC AND RF REGIMES

An identity of the parameters (β and A_e), in DC and RF regimes, was expected from the superposed protrusions explanation, which was ultimately based on the Fowler-Nordheim theory. The parameter β was considered as the result of a geometrical effect that enhanced the applied field **E**. The local field on the top of the micrometric protrusion raised to β_1 **E**. If this protrusion supported a much smaller one (of tens nanometer size), the final local field raised to β_2 (β_1 **E**). A comparison of these parameters on the same emitter would deny or consolidate such an explanation.

A first comparison had been attempted by Tan [6], on metallic particles, in our laboratory, and had given encouraging indications for identity, even though the DC current had been blurred by fluctuations. These fluctuations were found to be caused by adsorption [7]. With the help of a proper desorption, we renewed the comparison on crater-like emitters (Figure 1).



Figure 1 Crater-like emitter

	β_{RF}	β_{DC}	$A_{e RF}$ (m ²)	$A_{e DC}$ (m ²)
copper	274	260	2.3 10 ⁻¹⁶	4.8 10 ⁻¹⁶
niobium	222	214	10-16	1.7 10 ⁻¹⁶

Table 1Emitting characteristics in DC and RF regimes

Each emitter was intentionally prepared on the very clean surface of a small sample. Its characteristics were typically of $100 \,\mu\text{m}$ in diameter and $10 \,\mu\text{m}$ in height. The field emission current was measured versus the applied field first at 1.5 GHz, and next at DC field, in two distinct apparatus (a re-entrant cavity and a SEM equipped for field emission study [6]). Afterward, emission parameters were estimated from experimental data and modified Fowler-Nordheim's formulae.

$$I_{DC}(E) = A_{eDC} \frac{1.54 \times 10^{-6} \beta_{DC}^{2} E^{2}}{\phi} \exp\left(-\frac{6.83 \times 10^{9} \phi^{1.5}}{\beta_{DC} E}\right) \qquad \text{eq. 1}$$
$$< I_{RF}(E_{peak}) > = A_{eRF} \frac{M \beta_{RF}^{2.5} E_{peak}^{2.5}}{\phi^{7/4}} \exp\left(-\frac{6.83 \times 10^{9} \phi^{1.5}}{\beta_{RF} E_{peak}}\right) \qquad \text{eq. 2}$$

Full details about experimental set-up and procedure can be found elsewhere [8]. Very close characteristics were obtained (Table 1) provided that precautions were observed in order not to contaminate or modify physically the emitter between the RF and DC measurements.

In the DC regime, probing a crater-like with a small anode tip of a few microns radius curvature, in our SEM, had localized the electron sources on the crater rim. To check the same kind of distribution in the RF regime, an electronic pattern of the beam was obtained by focusing electrons with a magnetic lens on a phosphorescent screen [9]. Experimental patterns like that presented below (Figure 2) suggested a similar distribution.





Figure 2 Electronic pattern from a craterlike emitter in RF regime.

Simulated patterns with : A) uniform distribution of pin-point sources on the rim, B) single source.

Thanks to the electric and magnetic field maps given by a numerical code (URMEL), the electrons trajectories could be tracked, and simulated patterns obtained with specific electron source distributions on the rim (Figure 3). Clearly, the field emission current in RF regime also came from the protuberant rim of an emitter. The identity of the emitting characteristics and electron source localization, in both DC and

RF regimes, proved consistent the geometrical explanation for the enhanced emission. SRF97D21 983

3. - THERMAL AND MECHANICAL SURFACE TREATMENTS

One important consequence of the superposed protrusions explanation would be : a superficial damage of an emitter, by means of thermal or mechanical strain, should lead to a strong reduction of the undesired emission. There would be no need to remove completely a protrusion. This opened some new perspectives to fast, economical and easy treatments that we investigated.

3.1. - Electron beam surface heating

The idea consisted to melt superficially the protrusions using an intense electron beam provided by a electron welding apparatus. The treatments happened under secondary vacuum (10^{-4} Pa), thus prevented the surface from significant oxidizing. There were 4 critical beam parameters : voltage, current, diameter, and sweep frequencies. The voltage fixed the penetration depth, that also depended on the material density. For molybdenum and niobium, which density is respectively 1.02×10^4 kg.m⁻³ and 8.4×10^3 kg.m⁻³, a 25 kV beam dissipates in 1.5 µm. To produce a superficial melting on protrusions and not on the entire surface, the beam had to deposit locally a high power density in a short time. A thermal conduction model gave an estimation for the remaining key values [9]. The beam diameter was chosen 0.5 mm, the current 0.1 A, the highest sweep frequency 1000 Hz and the lowest 10 Hz (Figure 4). With this configuration, each point of the surface was exposed to a power density of 1.3×10^{10} W.m⁻² during 5 µs every 0.1 s.



3.1.1. - Molybdenum samples

A small surface less than 1 mm², mechanically polished with \emptyset 0.1 µm alumina paste, then carefully rinsed with ultra-pure water, was generally emission free, or at least SRF97D21 emitted a low current (< 0.1 μ A) up to 100 MV.m⁻¹. To evidence the treatment benefit, emitters were added to the surface by touching it slightly with a tungsten tip. The sample was first tested in the 1.5 GHz re-entrant cavity, then treated by the electron bombardment during 10 s and 1 s respectively for sample Mo1 and Mo2. Next, the sample was rinsed and tested again. At last, the emitted current, before and after the treatment was compared (Figure 5).



Figure 5

Surface heat treatment benefit on emission reduction

The treatment produced an important current reduction. It only remained to check that there were no strong physical modifications but superficial ones on the emitters. This was realized by comparing the pictures of emitters, taken in the SEM, before and after the treatment (Figure 6), that confirmed no visible change down to micron scale. A ten seconds treatment appeared more effective than its one second equivalent. The explanation lay on a cumulative effect that raised the bulk temperature of the sample from one sweep to another. Insofar as the maximum temperature, reached on

the top of a protrusion in a sweep, depends on the geometry and the sample initial temperature, a longer treatment favored a superficial melting.



Figure 6 SEM pictures of emitters before (left) and after (right) the treatment

3.1.2. - Niobium samples

To generalize these results, four niobium samples underwent the same treatment. Their surfaces were made very rough (Figure 7) in purpose, by grinding and scratching them, in order to test more severely the effectiveness of this kind of treatment.





Figure 7 Top view (left) and side view (right) of a rough niobium surface



Figure 8 RF emission current at 40 MV.m⁻¹, before and after a surface heat treatment, on 4 niobium samples

Currents were measured at 40 MV.m⁻¹ once again before and after a 10 seconds treatment (Figure 8). Conclusion was straightforward. All these results supported the explanation that protrusions on a micrometric protrusion played a critical role.

3.2. - High Pressure Water Rinsing (HPWR)

This procedure consisted to direct a high pressure water jet, generally of 10 MPa, on the surface to be rinsed. It proved very effective to reduce field emission in superconducting cavities [10]. High performance single cell cavities were obtained with good reproducibility recently [11].

The success of such treatment was attributed only to a dust removal; contamination particles were drift by the flow. Indeed, even at normal incidence, the mechanical strain created by a continuous jet on the surface would be much inferior to the tensile strength of niobium (~ 200 MPa). With a pressure of 10 MPa, the pumping group delivered 10 liters of water per minute through two 0.8 mm diameter orifices in the nozzle. This corresponded to a jet velocity of 166 m.s⁻¹, giving a strain of 14 MPa ($\rho v^2/2$ where ρ is the water density).

However, the continuous jet should be surrounded by a sheath of droplets drift with a velocity near that of the core. The impacts of such droplets are amplified by a shock wave effect [12], known as « hammering effect ». The resulting mechanical strain can overreach 250 MPa (ρ u v where u is the sound velocity in water). From this analysis, it was allowed to expect some erosion effect or a more noticeable modification on intrinsic protuberant defects.

To check the predictable effect, the morphology of emitters on 4 niobium samples had been examined in a SEM before and after HPWR (Figure 9, Figure 10, Figure 11 and Figure 12). The rinsing apparatus was similar to it equivalent at CEBAF [10], with the difference, nevertheless, that our nozzle included only two orifices instead of eighteen .

Pressure and delivery took the values in the previous analysis. The surfaces under study SRF97D21 987

were placed at a distance from the nozzles, equal to the iris radius of a 1.3 GHz cavity. They went twice (up and down) past of the nozzle, animated with a circular movement of one lap every 3 seconds, as a surface of a cavity under rinsing would. Before the treatment, surfaces emitted currents around 1 μ A at 40 MV.m⁻¹. These currents fell down to 1 nA, while the detection threshold being 0.1 nA. This result was common to every surface which emitters underwent more or less noticeable modifications.

As a conclusion, this experiment pointed out a stronger mechanical effect of HPWR on a niobium surface, in addition to a dust removal. This effect originates in the structure of a real high pressure jet, which can be controlled by optimizing the nozzle geometry.



Before HPWR









Figure 9 Emitter morphology change during HPWR on sample Nb1

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After HPWR

Figure 10 Emitter morphology change during HPWR on sample Nb2



Before HPWR







Figure 11 Emitter morphology change during HPWR on sample Nb3

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Before HPWR



After HPWR



4. - IN SITU RF PROCESSING

The in situ RF processing often remains the treatment in the last resort, when a cavity is subjected to field emission, once mounted in its operational environment. It consists of applying repetitively a high electric field on a surface during a short time ; i.e. feeding a cavity with high power pulses. Such a high peak power processing (HPPP) had proved generally effective in the field emission eradication [13, 14]. Nevertheless, a few failures had also been observed. Studies were going on in order to get a better understanding of the processing mechanism, and infer a more reproducible procedure. In our laboratory, we had already investigated a possible impact of the thermal and mechanical properties (melting point and tensile strength) of the metal that composed a protrusion [15]. The experiment had not found any linear relation between these properties and the final characteristics (β , A_e), but had brought out a current density limit (10¹² A.m⁻²) beyond which a run away phenomenon was initiated. This current density limitation allowed a prediction of the processing effectiveness in term of field enhancement factor. Using (eq. 2), it was possible to compute the maximum value of β for the dominant emitter on a surface processed at a given field \mathbf{E}_{max} . The prediction was compared to several experimental results : Tan's [16], Wang's [17], Tanabe's [18] and ours (Figure 13).



This picture indicate the good correlation between prediction and experiment, hence the importance of the current density limit. It also stresses on how worth a processing at 200 MV.m⁻¹ could be, for a surface that have to sustain a nominal 50 MV.m⁻¹.

A processed surface showed evidences of molten craters. Their diameter ranked at a few microns (Figure 14). Creation of molten crater were thought related to important sudden current drops observed as the field were raising during the processing.



processed surface

Positive ion burst (left) and luminous spot (right) associated with a processing event on a copper sample In a recent experiment, we monitored the current signal and luminous emission signal. The samples were processed in a cavity equipped with an optical line [19]. This allowed to correlate the both signals inside a macro-pulse (1 ms) and from a pulse to another. Generally, a processing event was preceded by weak current fluctuations that quickly ended in a current inversion, i.e. burst of positive ions. The inversion began in the middle of a macro-pulse ; at the time, a luminous emission was detected (Figure 15).

Very short (few nanoseconds) luminous spot had been reported on DC cathodes [20]. Here, the much longer spot rather suggested a thermal emission by a small pool of molten copper. This emission would have a spread spectrum. Knowing the pass band (180-850 nm) of the photo-amplifier, the detection solid angle ($\Omega = 2.5 \times 10^{-3}$ steradian) and transmission efficiency ($\eta = 0.6$) of the optical line, it was possible to estimate the measured power. Let us consider a molten copper pool (\emptyset 5 µm) of area A_f, at a temperature of 1356 K, emitting in a hemisphere as a gray body. At that temperature, the emissivity ε_T would be 0.16. Then the power wrote :

$$P = \eta \frac{\Omega}{2 \pi} A_f \varepsilon_T \int_{180-850 \text{ nm}} \pi L_{\lambda}^{\circ} d\lambda, \qquad \text{eq. 3}$$

where L_{λ}^{0} represented the black body luminance. This gave $P = 1.3 \times 10^{-13}$ W, which was close to the measured value.

Finally, we have evidenced the part played by a high current density, confirmed the generation of a micro-plasma in processing events, and got an insight into their dynamics. Computational studies on micro-plasma ignition and growing are being undertaken by Padamsee and Knobloch at Cornell University.

5. - CONCLUSION

These experimental studies proved the consistency of the superposed protrusions explanation for the most dangerous emitters, the conducting protrusions. The idea of wearing out the protrusions to suppress the enhanced field emission had operated successfully. By extension, every processes that could smooth a surface without contaminating it would be effective. Simulations of in situ RF processing on samples provided several practical indications on its mechanism and limitation. Nevertheless, they did not lead to a guideline for the best operational scenario, if ever this could exist. As a matter of fact, the geometry of a protrusion must play a significant part in how the current density reaches its limit value. On a real surface, emitters do have a random geometry. As a prospective statement for high gradient accelerating cavities, the finding of a non contaminating assembling method will remain the major challenge, while high pressure rinsing effectiveness can be improved.

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